

FIG. 1

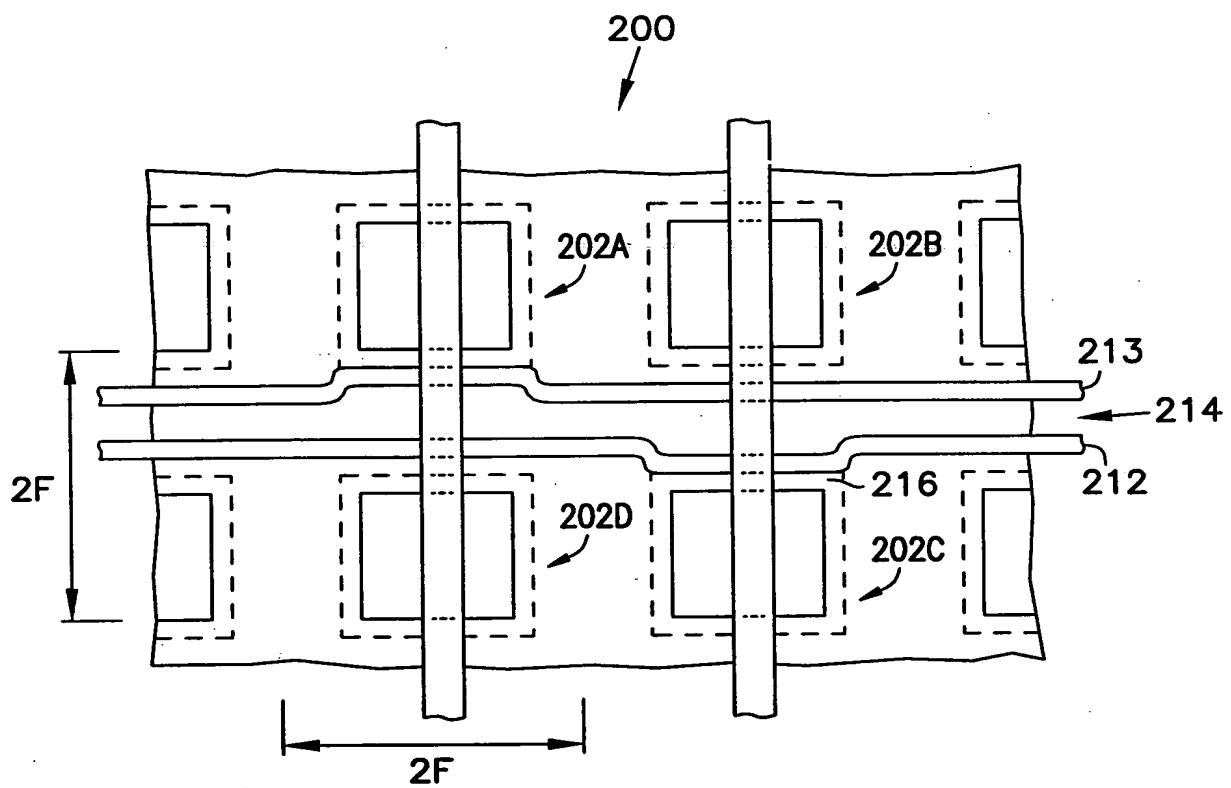


FIG. 2

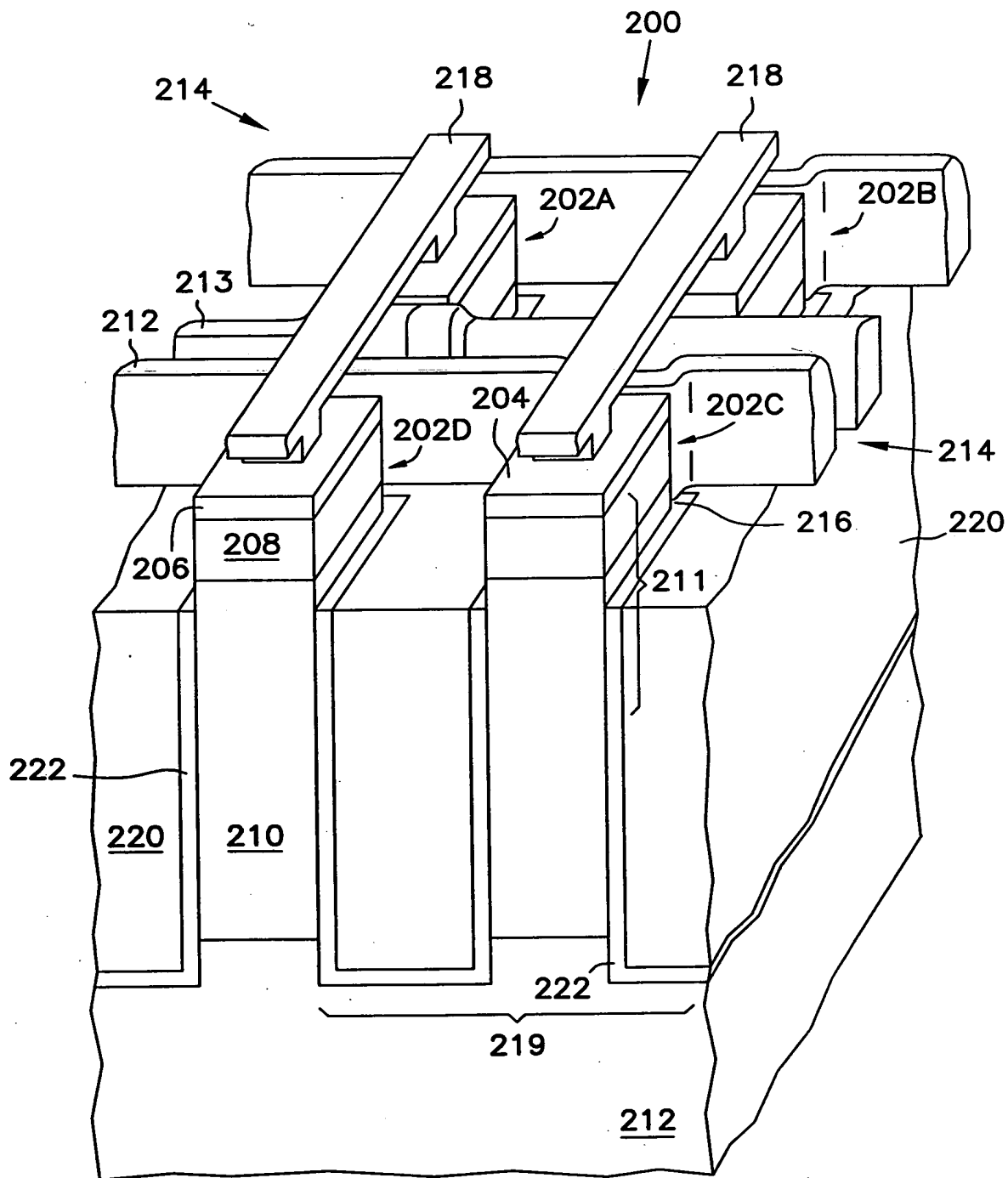


FIG. 3

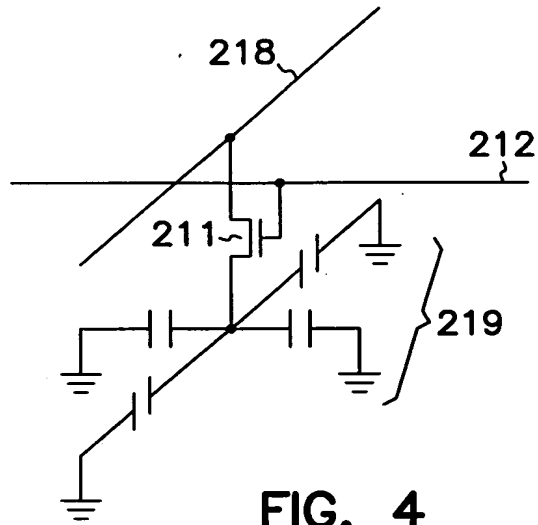


FIG. 4

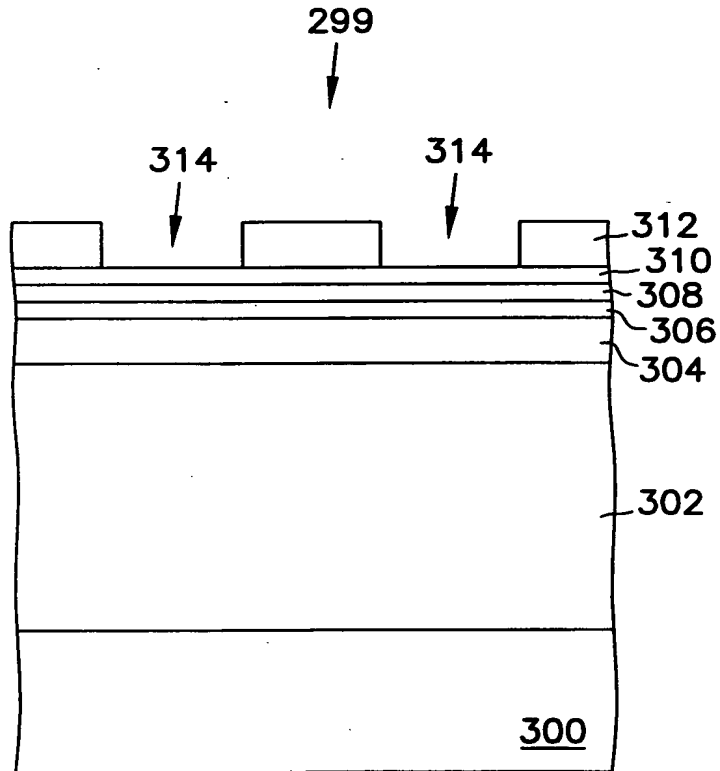


FIG. 5A

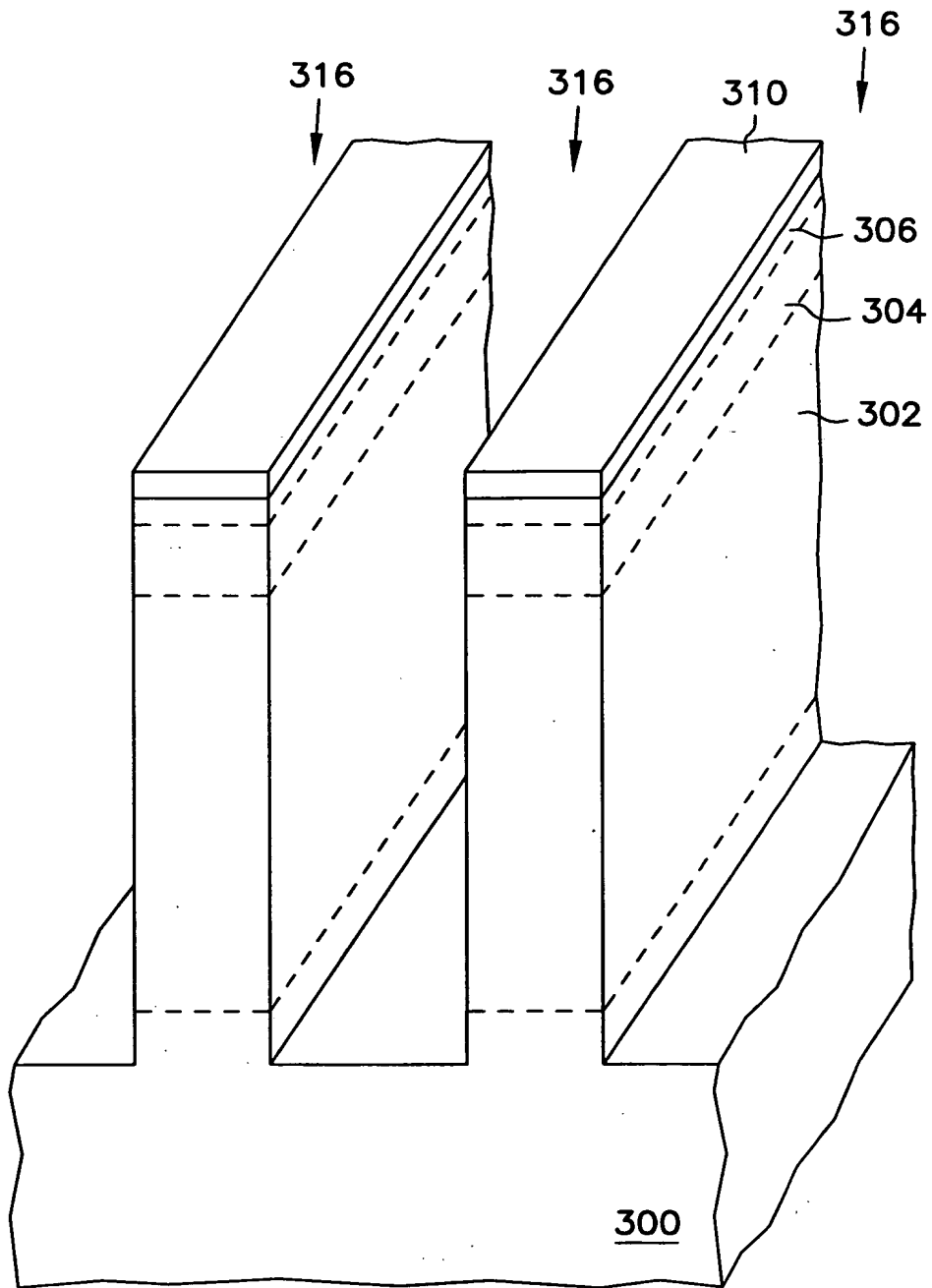


FIG. 5B

FIG. 5C is a cross-sectional view of a device 300, showing a substrate 302 with a central region 304. A layer 306 is formed on the top surface of the substrate 302, and a layer 310 is formed on the top surface of the central region 304. A layer 322 is formed on the top surface of the substrate 302, and a layer 320 is formed on the top surface of the central region 304. A layer 318 is formed on the bottom surface of the substrate 302.

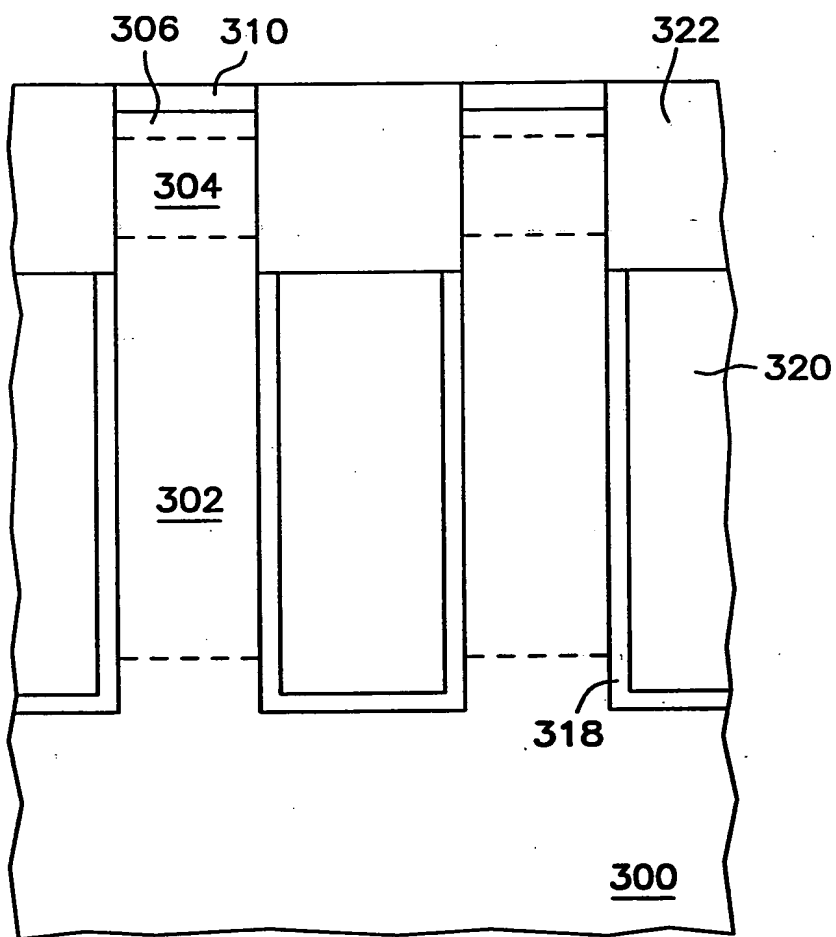


FIG. 5C

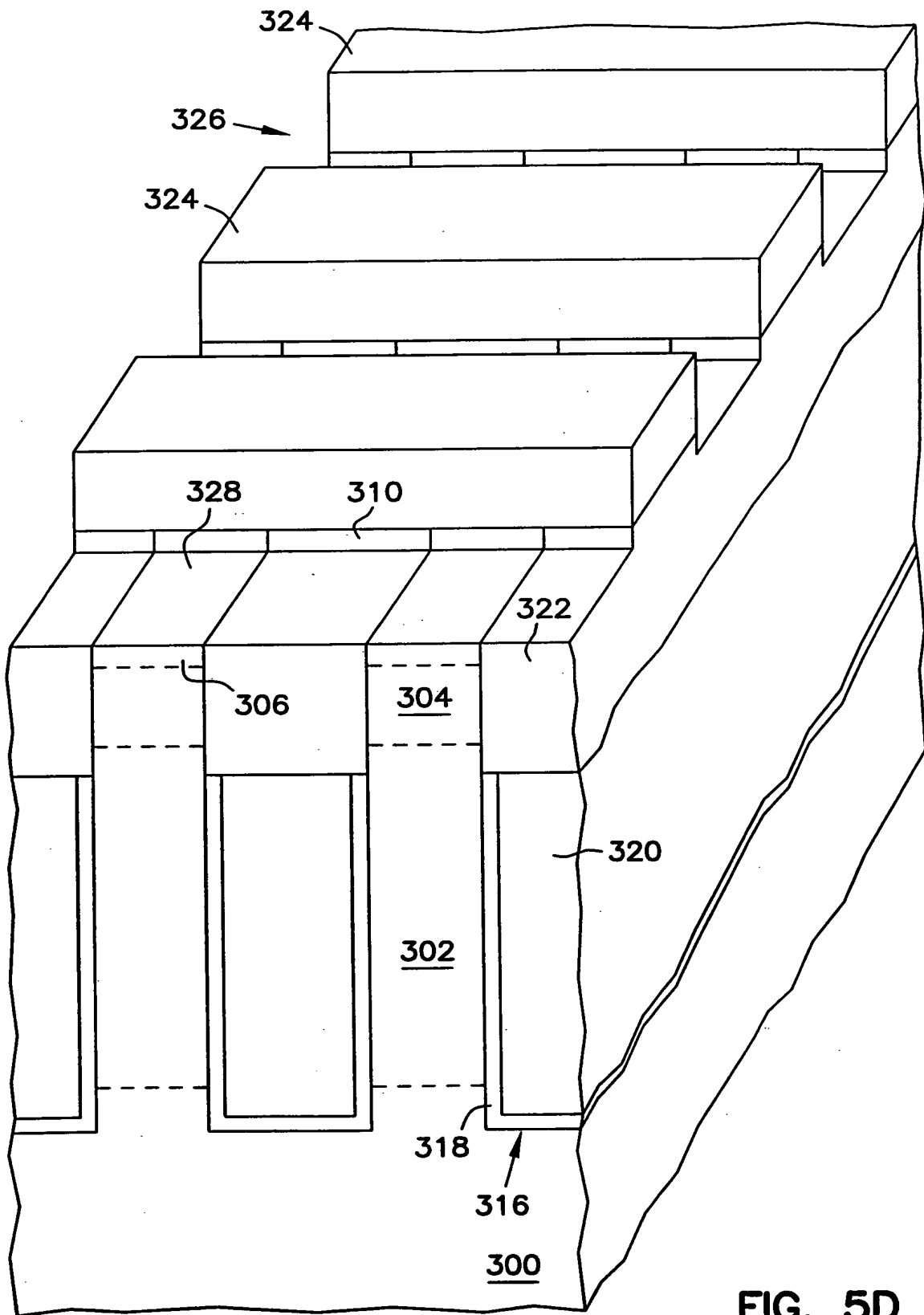


FIG. 5D

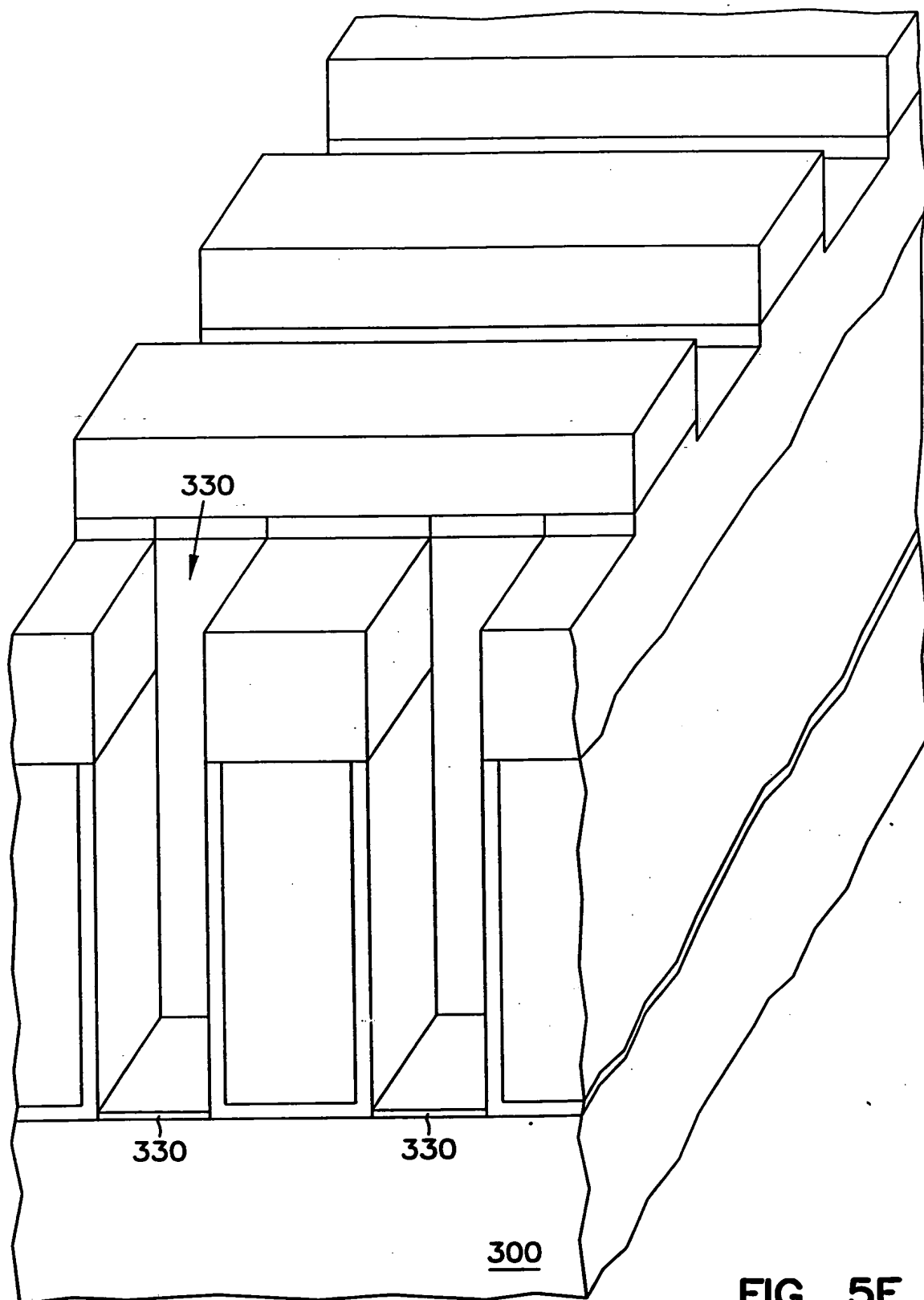


FIG. 5E

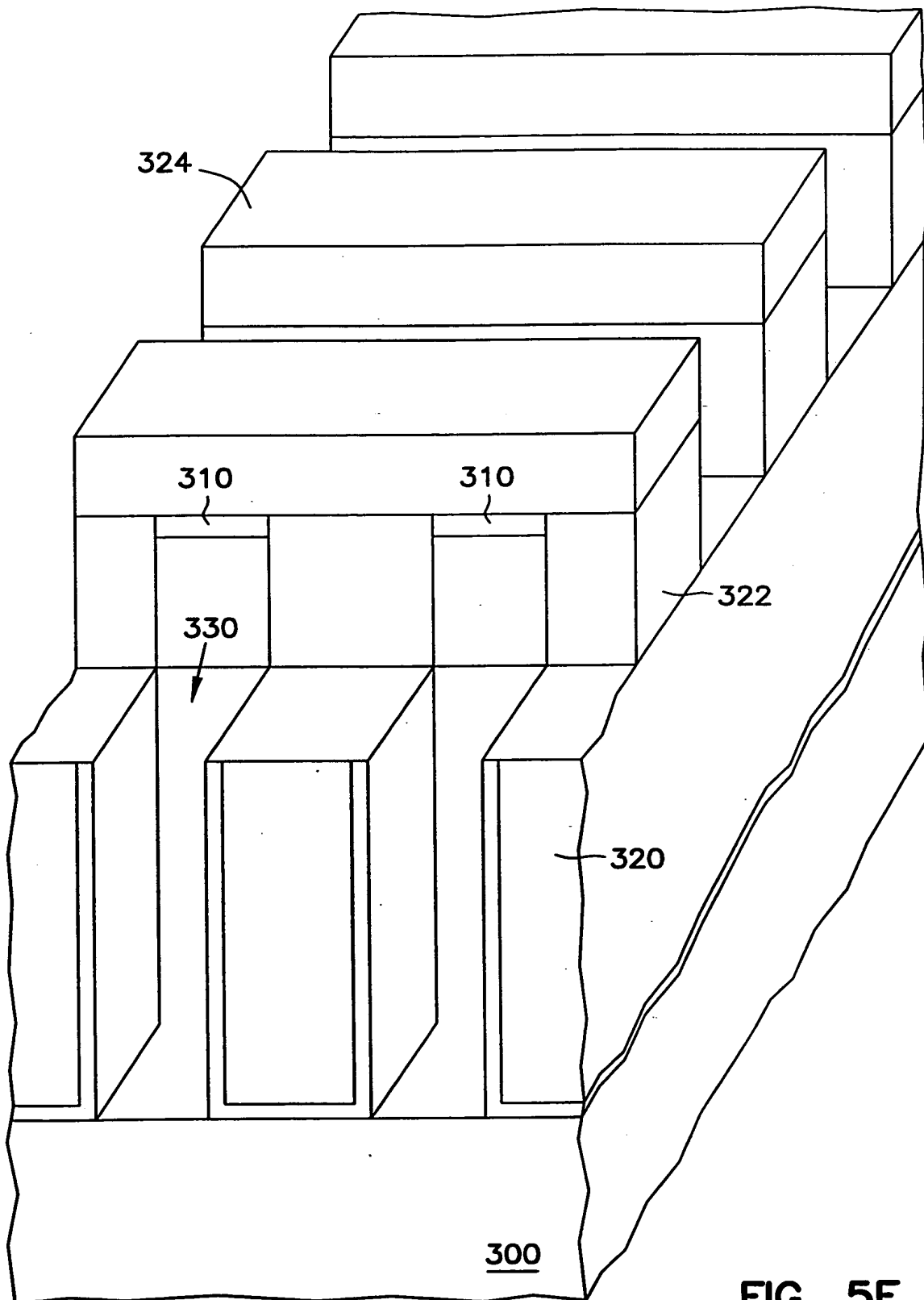


FIG. 5F

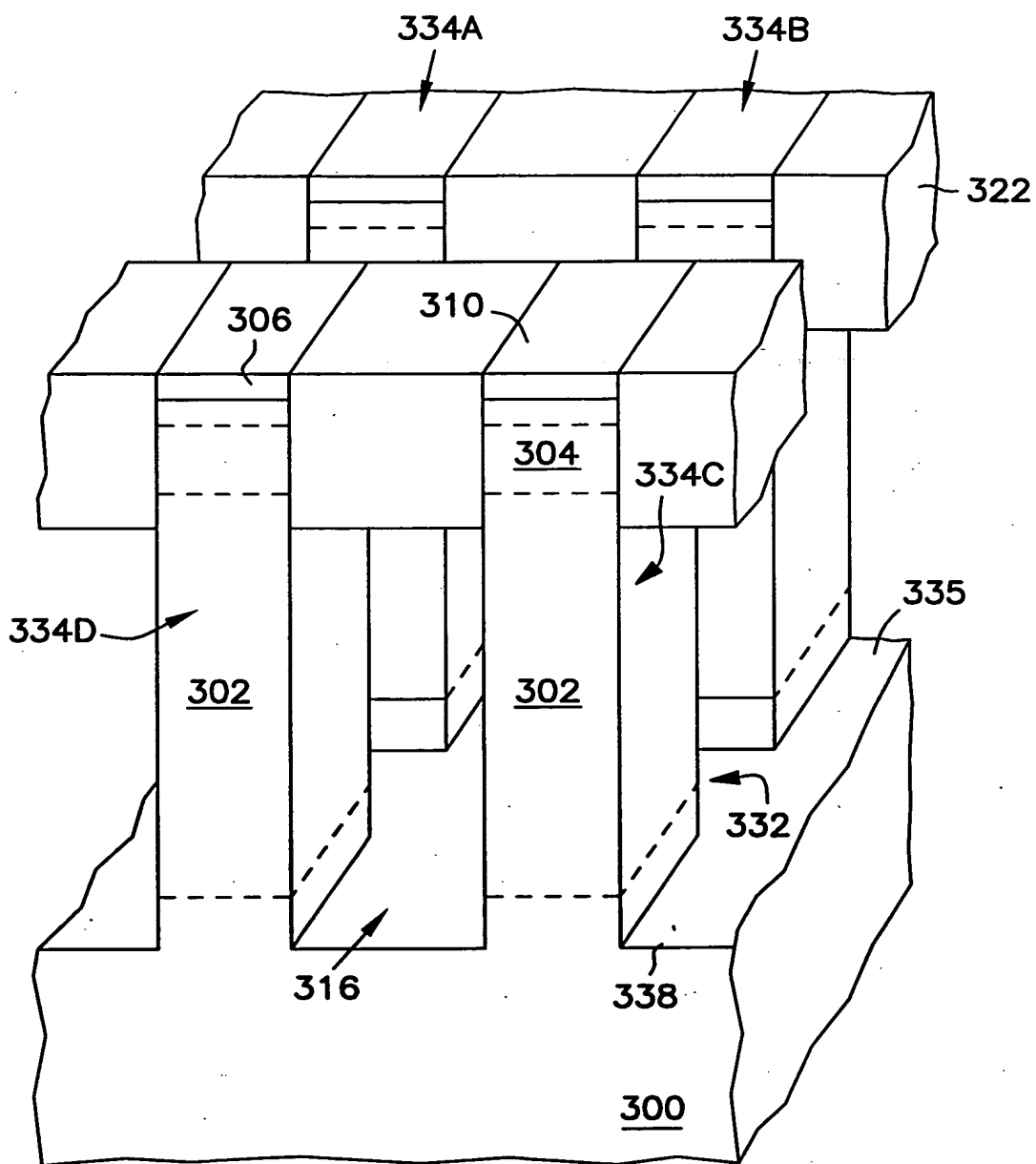


FIG. 5G

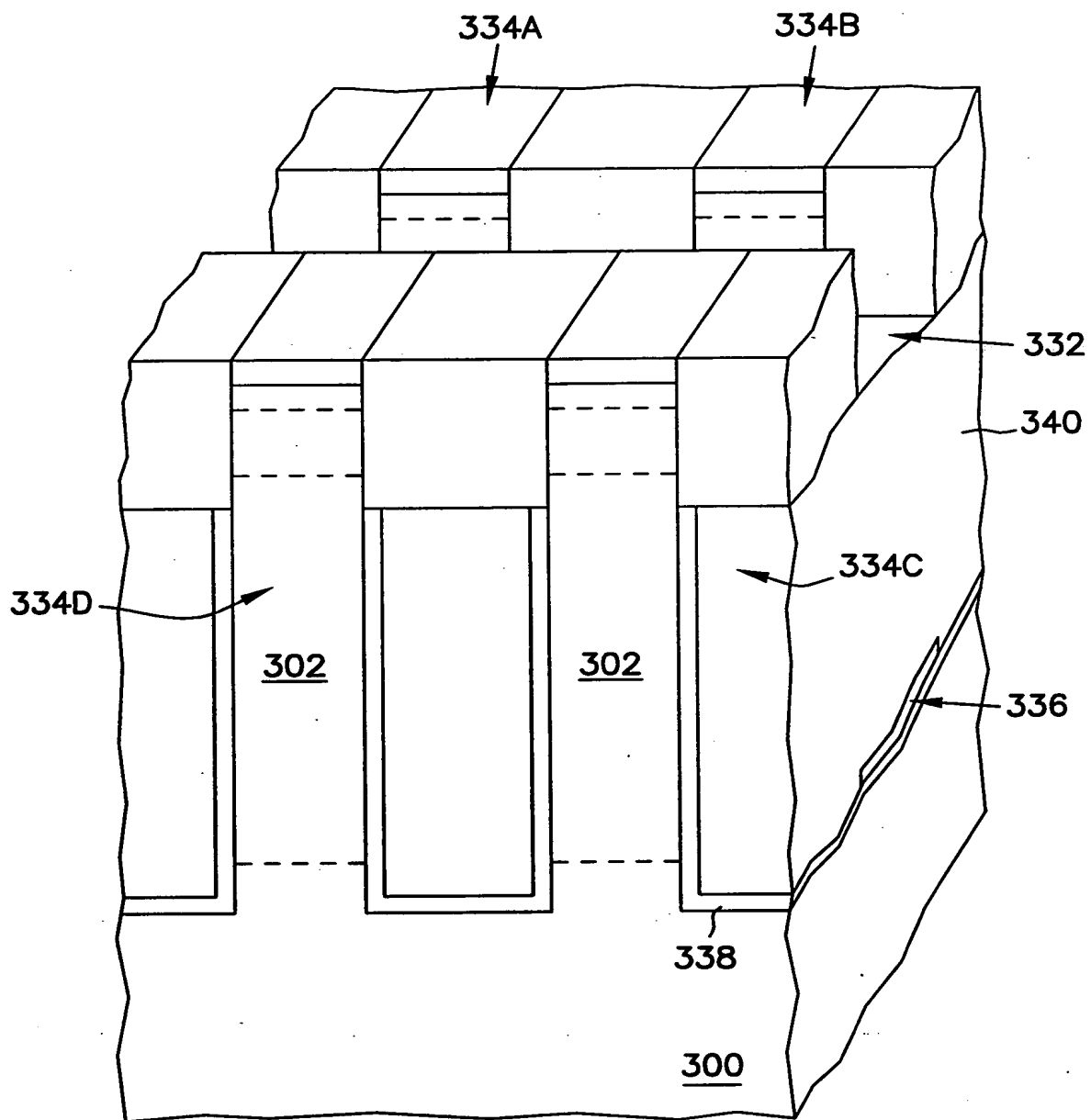


FIG. 5H



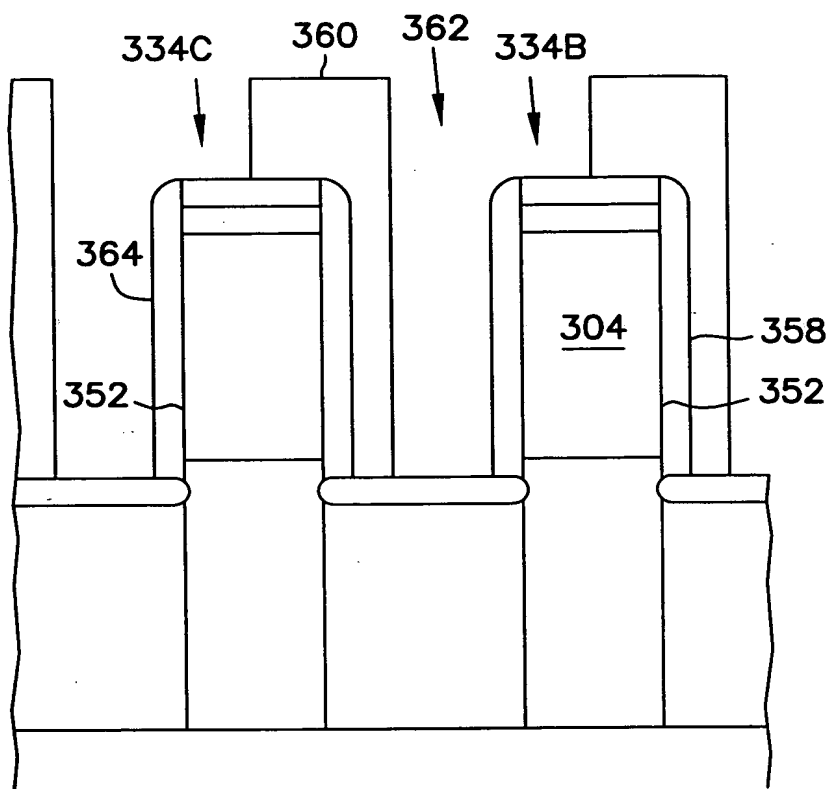


FIG. 5J



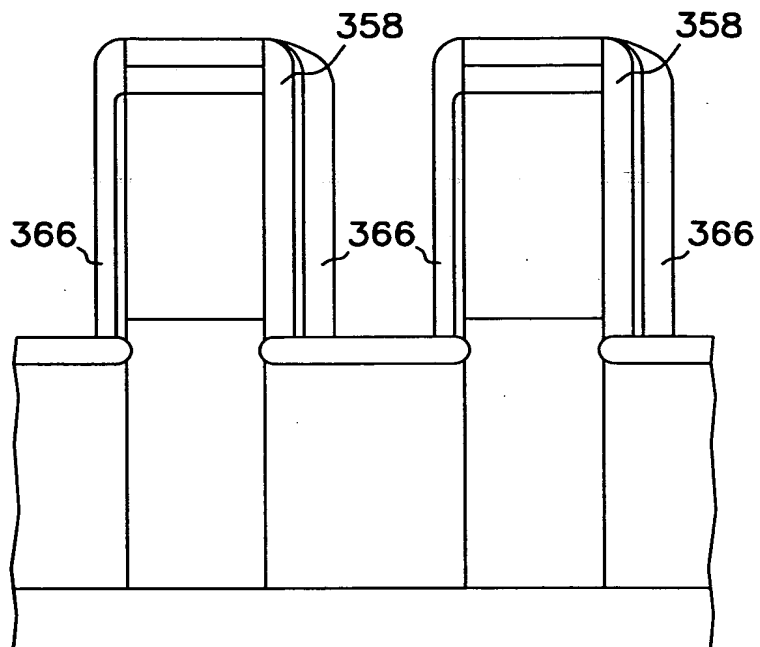


FIG. 5L

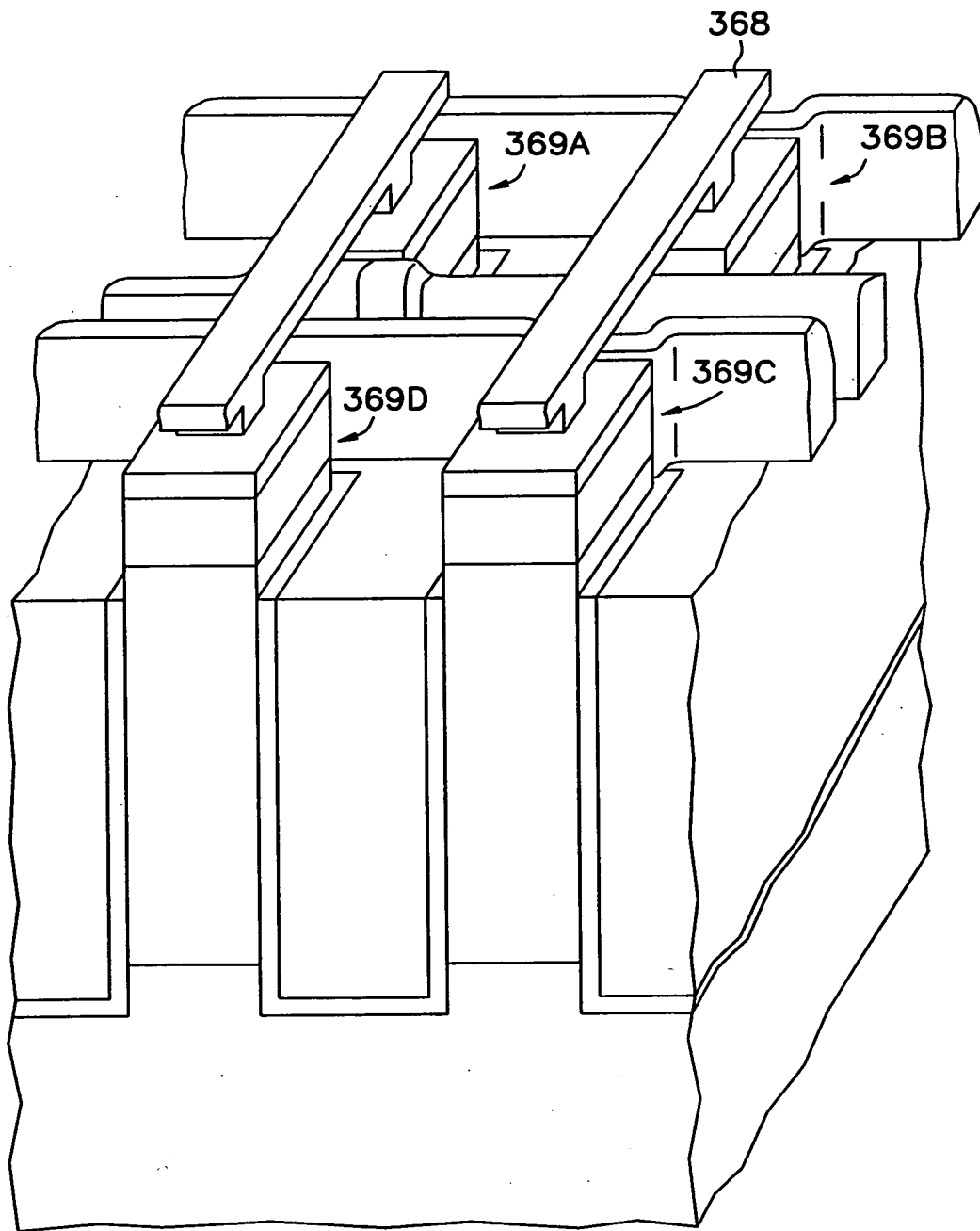


FIG. 5M